

Power 56

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MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units
V _{DS}	Drain to Source Voltage			25	V
V _{GS}	Gate to Source Voltage			12	V
I _D	Drain Current -Continuous (Package limited)	T _C = 25 °C	60		
	-Continuous	T _A = 25 °C	(Note 1a)	24	Α
	-Pulsed			100	
E _{AS}	Single Pulse Avalanche Energy (Note 3)		(Note 3)	45	mJ
P _D	Power Dissipation	T _C = 25 °C		48	W
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	VV
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	T _C = 25 °C	2.6	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1a	50	C/vv

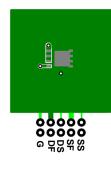
Package Marking and Ordering Information

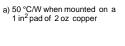
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
10OD	FDMS8570S	Power 56	13"	12 mm	3000 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	octeristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0 V	25			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 10$ mA, referenced to 25 °C		23		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 20 V, V_{GS} = 0 V$			500	μA
I _{GSS}	Gate to Source Leakage Current	V_{GS} = +12 V/-8 V, V_{DS} = 0 V			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1 \text{ mA}$	1.1	1.5	2.2	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 10 \text{ mA}$, referenced to 25 °C		-3		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 24 A		2.1	2.8	
		$V_{GS} = 4.5 \text{ V}, I_D = 22 \text{ A}$		2.4 3.1		mΩ
		V_{GS} = 10 V, I _D = 24 A, T _J = 125 °C		2.9	3.9	1
9 _{FS}	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 24 A$		215		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			2825		pF
C _{oss}	Output Capacitance	── V _{DS} = 13 V, V _{GS} = 0 V, f = 1 MHz		662		pF
C _{rss}	Reverse Transfer Capacitance			94		pF
Rg	Gate Resistance			0.8		Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			11		ns
t _r	Rise Time	V _{DD} = 13 V, I _D = 24 A,		4		ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		33		ns
t _f	Fall Time			3		ns
Q _g	Total Gate Charge	V _{GS} = 0 V to 10 V		42		nC
Q _q	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$ $V_{GS} = 0 V \text{ to } 4.5 V$ $V_{DD} = 13 V$,		22		nC
Q _{gs}	Gate to Source Gate Charge	I _D = 24 A		6.4		nC
Q _{gd}	Gate to Drain "Miller" Charge			4.4		nC
Drain-Sou	urce Diode Characteristics					
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.6	0.8	
		$V_{GS} = 0 V, I_S = 24 A$ (Note 2)		0.8	1.2	V
t _{rr}	Reverse Recovery Time	—I _F = 24 A, di/dt = 300 A/μs		22		ns
Q _{rr}	Reverse Recovery Charge	$F = 24 \text{ A}, \text{ u/ul} = 300 \text{ A/}\mu\text{S}$		19		nC





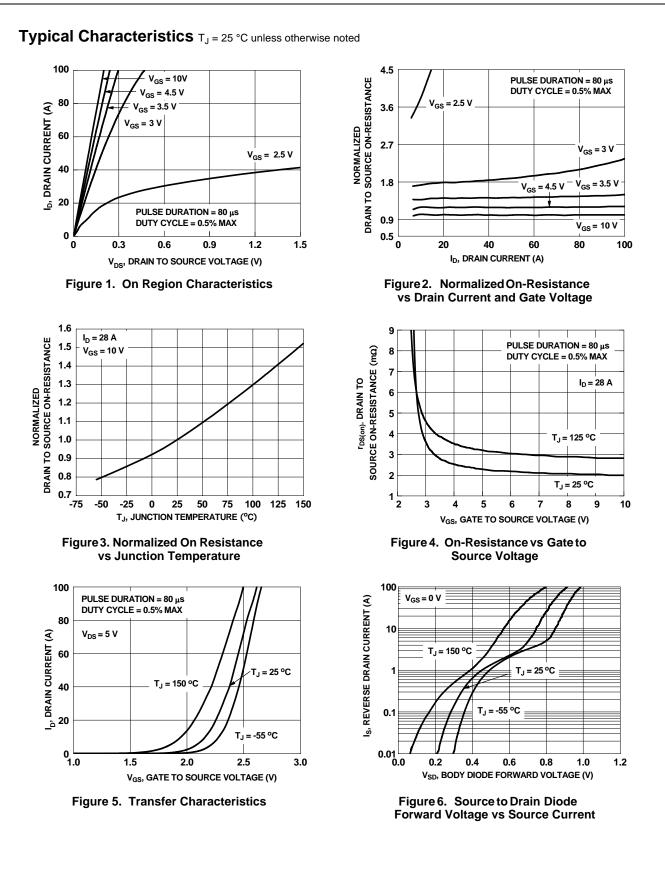


b) 125 °C/W when mounted on a minimum pad of 2 oz copper.

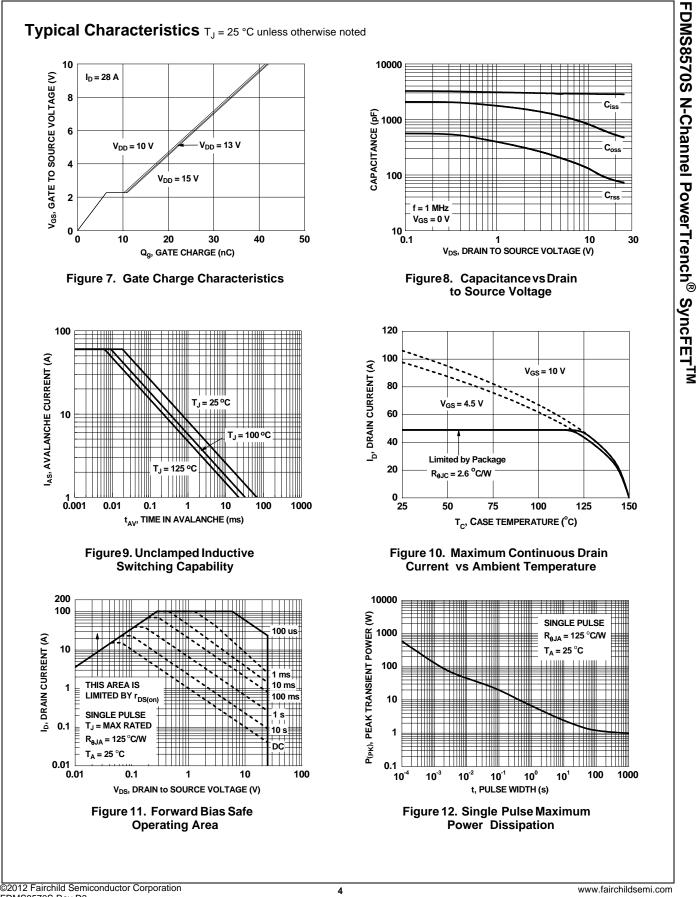
2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. 3. E_{AS} of 45 mJ is based on starting T_J = 25 °C, L = 0.4 mH, I_{AS} = 15 A, V_{DD} = 23 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 23.8 A.

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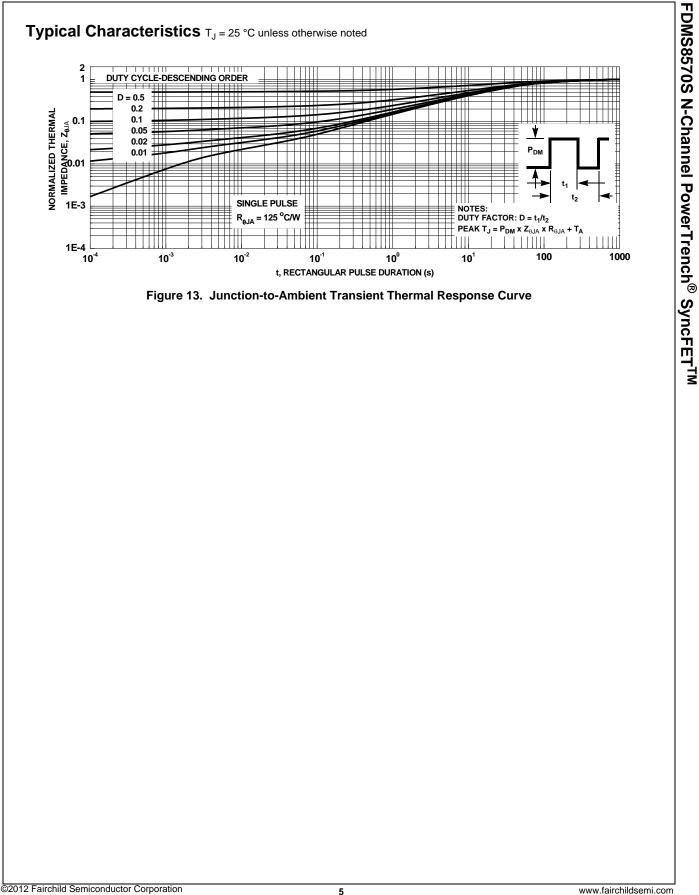
FDMS8570S N-Channel PowerTrench[®] SyncFETTM



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FDMS8570S N-Channel PowerTrench[®] SyncFETTM

Typical Characteristics (continued)

SyncFET[™] Schottky body diode Characteristics

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10 5

0

-5

0

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CURRENT (A)

Fairchild's SyncFETTM process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverse recovery characteristic of the FDMS8570S.

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

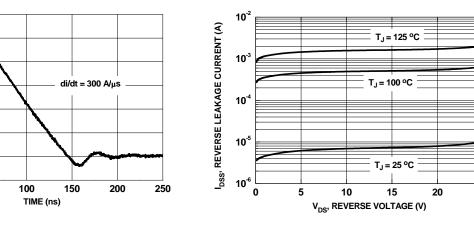
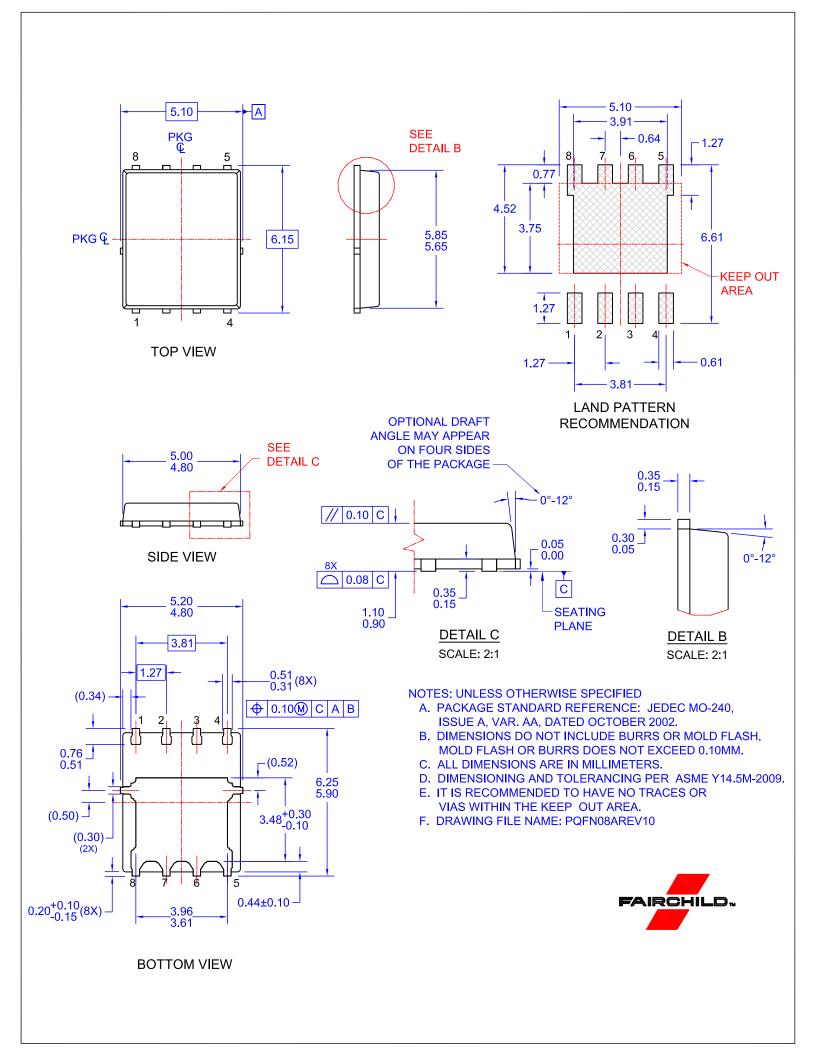


Figure 14. FDMS8570S SyncFETTM body diode reverse recovery characteristic

Figure 15. SyncFETTM body diode reverse leakage versus drain-source voltage

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